503274073 04/22/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date	
YUAN-HUNG LIU	02/15/2011	
KU-FENG YANG	02/15/2011	
PEI-CHING KUO	02/15/2011	
MING-TSU CHUNG	02/15/2011	
HSIN-YU CHEN	02/15/2011	
TSANG-JIUH WU	02/15/2011	
WEN-CHIH CHIOU	02/15/2011	

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14692799	

CORRESPONDENCE DATA

Fax Number: (703)518-5499

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7036841111
Email: tsmc@ipfirm.com

Correspondent Name: LOWE HAUPTMAN & HAM, LLP (TSMC)

Address Line 1: 2318 MILL ROAD Address Line 2: SUITE 1400

Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: T5057-R425A

NAME OF SUBMITTER: RANDY A. NORANBROCK

SIGNATURE: /Randy A. Noranbrock/

DATE SIGNED: 04/22/2015

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Total Attachments: 2 source=efiledassgn#page1.tif source=efiledassgn#page2.tif

PATENT REEL: 035465 FRAME: 0853

ASSIGNMENT

In consideration of the premises and	other good and valuable	consideration in hand p	paid, the receipt and	d sufficiency of
which is hereby acknowledged, the undersigne	d,			

1)	Yuan-Hung LIU	5)	Hsin-Yu CHEN		
2)	Ku-Feng YANG	6)	Tsiang-Jiuh WU		
3)	Pei-Ching KUO	7)	Wen-Chih CHIOU		
. 4)	Ming-Tsu CHUNG				
who has made	a certain new and useful invention, here	by sells,	assigns and transfers unto		
TAIWAN S	SEMICONDUCTOR MANUFA	CTUR	UNG COMPANY, LTD. having a place of business at No		
8, Li-Hsin 1	Rd. VI, Hsinchu Science Park, I	Isinch	1 300, Taiwan R.O.C.		
	and assigns (hereinafter designated "ASS) 5 U.S.C. 100 in the invention entitled	IGNEE")	the entire right, title and interest for the United States of America		
INTEGRA	TED CIRCUITS INCLUDING	COND	UCTIVE STRUCTURES THROUGH A		
SUBSTRA'	TE AND METHODS OF MAK	ING T	HE SAME		
(a) for w	hich an application for United States Lett s Patent Application No. 13/033, 7	ers Paten 33	t was filed on $2-24-2011$, and identified by United; or		
(b) for w	hich an application for United States Lett	ers Paten	t was executed on,		
 all United State continuations-in Property to the 	es Letters Patent which may be granted in-part thereof, and the right to all ben	therefore efits und SIGNEE,	States Commissioner of Patents and Trademarks to issue any and and any and all extensions, divisions, reissues, continuations, or ler the International Convention for the Protection of Industrial its successors, assigns and legal representatives; the undersigned fler act on behalf of said ASSIGNEE;		
application for ASSIGNEE, it applications for ASSIGNEE, it	and obtaining original, divisional, reissues successors, assigns and legal representator patent based thereon, growing out of	ed or extentives, and or relate	ike interest, and to render all necessary assistance in making ended Letters Patent of the United States, upon request of the said id without further remuneration, in and to any improvements, and to the said invention; and to execute any papers by the said exemed essential to ASSIGNEE's full protection and title in and to		
SIGNED on th	e date indicated aside my signature:				
1) Yuan Name: Yuan	-Hung Licy		2011 /2 /15 Date:		
in ku	-Feng Jang eng YANG		2011 /2/15— Date:		
Name: Ku-F	eng YANG		Date:		
3) _ Rh	40		Pckuo 2011/2/15		
Name: Pei-Ching KUO Date:					

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